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Kind regards,

Team Nexperia

# 74LV123

## Dual retriggerable monostable multivibrator with reset

Rev. 8 — 4 March 2016

Product data sheet

### 1. General description

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The 74LV123 is a low-voltage Si-gate CMOS device and is pin and function compatible with the 74HC123; 74HCT123. It is a dual retriggerable monostable multivibrator which uses three methods to control the output pulse width:

1. The basic pulse time is programmed by the selection of an external resistor ( $R_{EXT}$ ) and capacitor ( $C_{EXT}$ ). These are normally connected as shown in [Figure 9](#).
2. Once triggered, the basic output pulse width may be extended by retriggering the gated active LOW-going edge input ( $n\bar{A}$ ) or the active HIGH-going edge input ( $nB$ ). By repeating this process, the output pulse period ( $nQ = \text{HIGH}$ ,  $n\bar{Q} = \text{LOW}$ ) can be made as long as desired (see [Figure 12](#)).
3. Alternatively, an output delay can be terminated at any time by a LOW-going edge on input  $n\bar{RD}$ , which also inhibits the triggering (see [Figure 13](#)).

Schmitt-trigger action in the  $n\bar{A}$  and  $nB$  inputs makes the circuit highly tolerant of slower input rise and fall times.

### 2. Features and benefits

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- Optimized for low-voltage applications: 1.0 V to 5.5 V
- Accepts TTL input levels between  $V_{CC} = 2.7 \text{ V}$  and  $V_{CC} = 3.6 \text{ V}$
- Typical output ground bounce:  $< 0.8 \text{ V}$  at  $V_{CC} = 3.3 \text{ V}$  and  $T_{amb} = 25 \text{ }^\circ\text{C}$
- Typical HIGH-level output voltage ( $V_{OH}$ ) undershoot:  $> 2 \text{ V}$  at  $V_{CC} = 3.3 \text{ V}$  and  $T_{amb} = 25 \text{ }^\circ\text{C}$
- DC triggered from active HIGH or active LOW inputs
- Retriggerable for very long pulses up to 100 % duty factor
- Direct reset terminates output pulses
- Schmitt-trigger action on all inputs except for the reset input

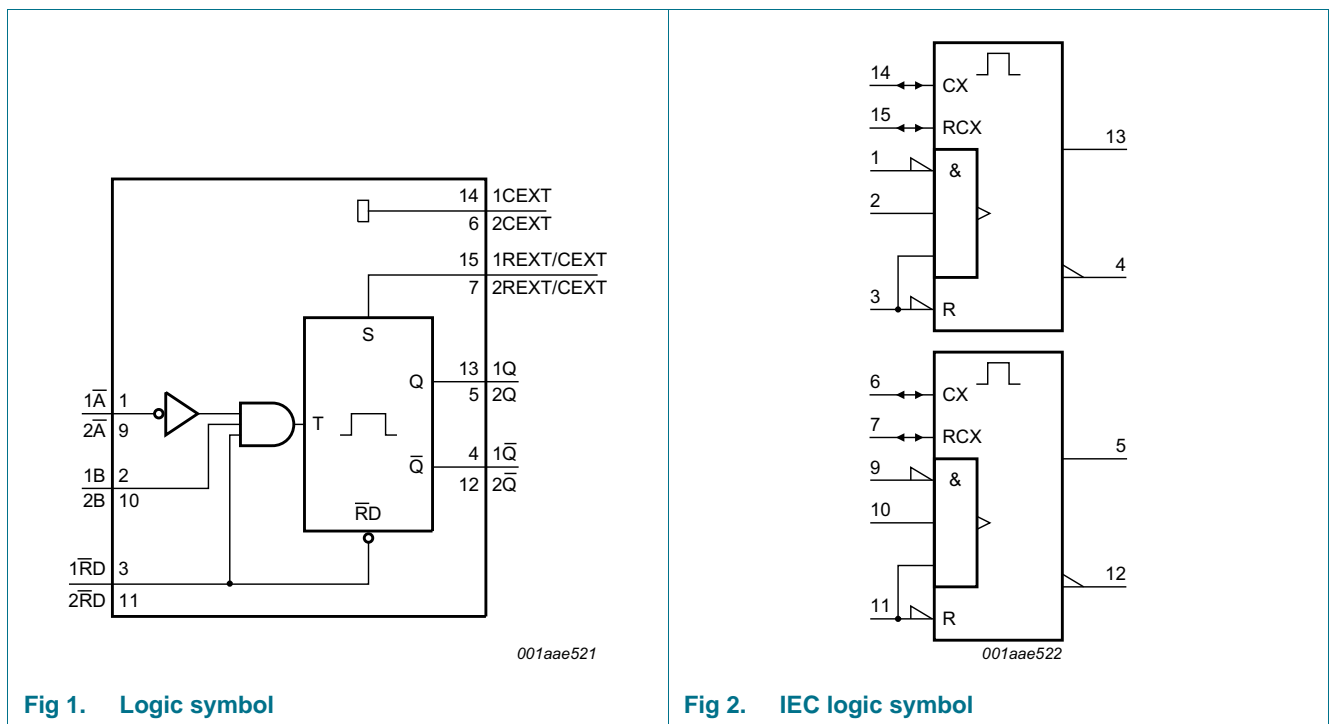


### 3. Ordering information

Table 1. Ordering information

| Type number | Package           |          |  | Version  |
|-------------|-------------------|----------|--|----------|
|             | Temperature range | Name     | Description  |          |
| 74LV123D    | -40 °C to +125 °C | SO16     | plastic small outline package; 16 leads; body width 3.9 mm   | SOT109-1 |
| 74LV123DB   | -40 °C to +125 °C | SSOP16   | plastic shrink small outline package; 16 leads; body width 5.3 mm  | SOT338-1 |
| 74LV123PW   | -40 °C to +125 °C | TSSOP16  | plastic thin shrink small outline package; 16 leads; body width 4.4 mm   | SOT403-1 |
| 74LV123BQ   | -40 °C to +125 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm | SOT763-1 |

### 4. Functional diagram



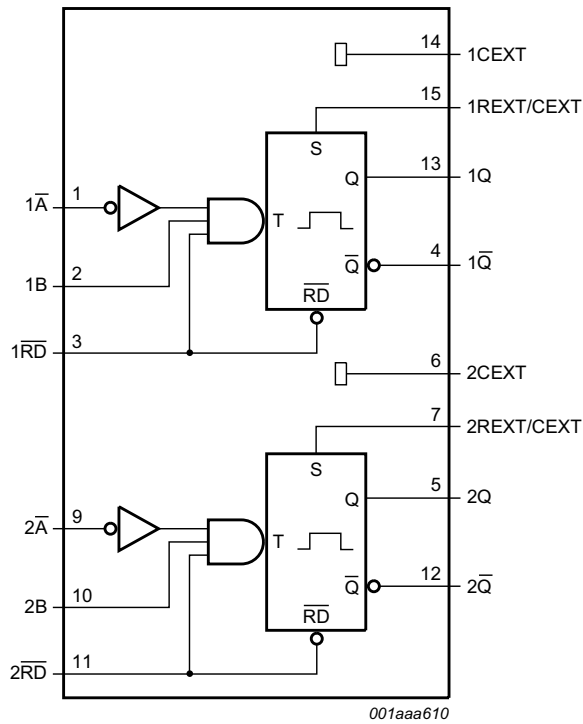


Fig 3. Functional diagram

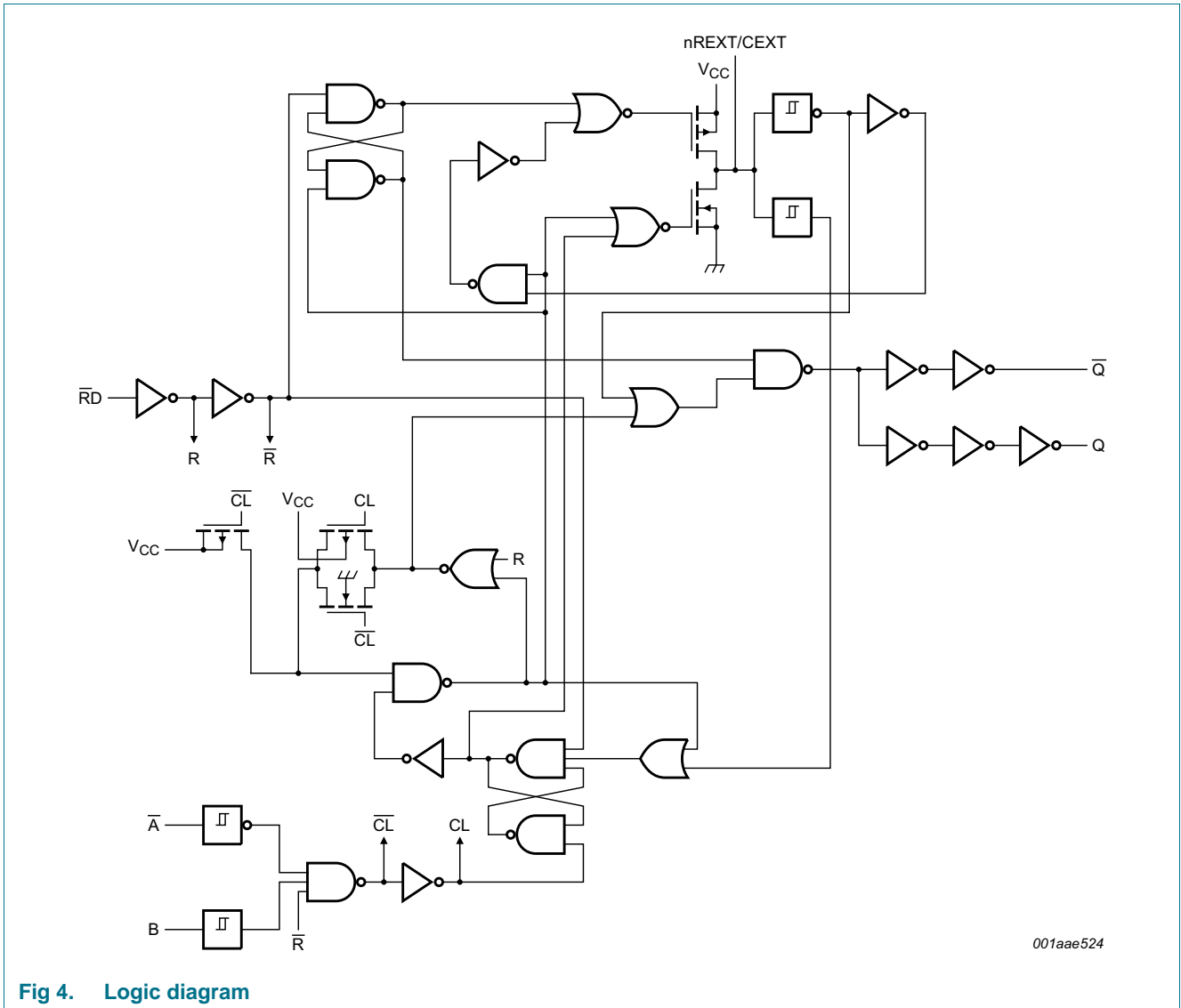
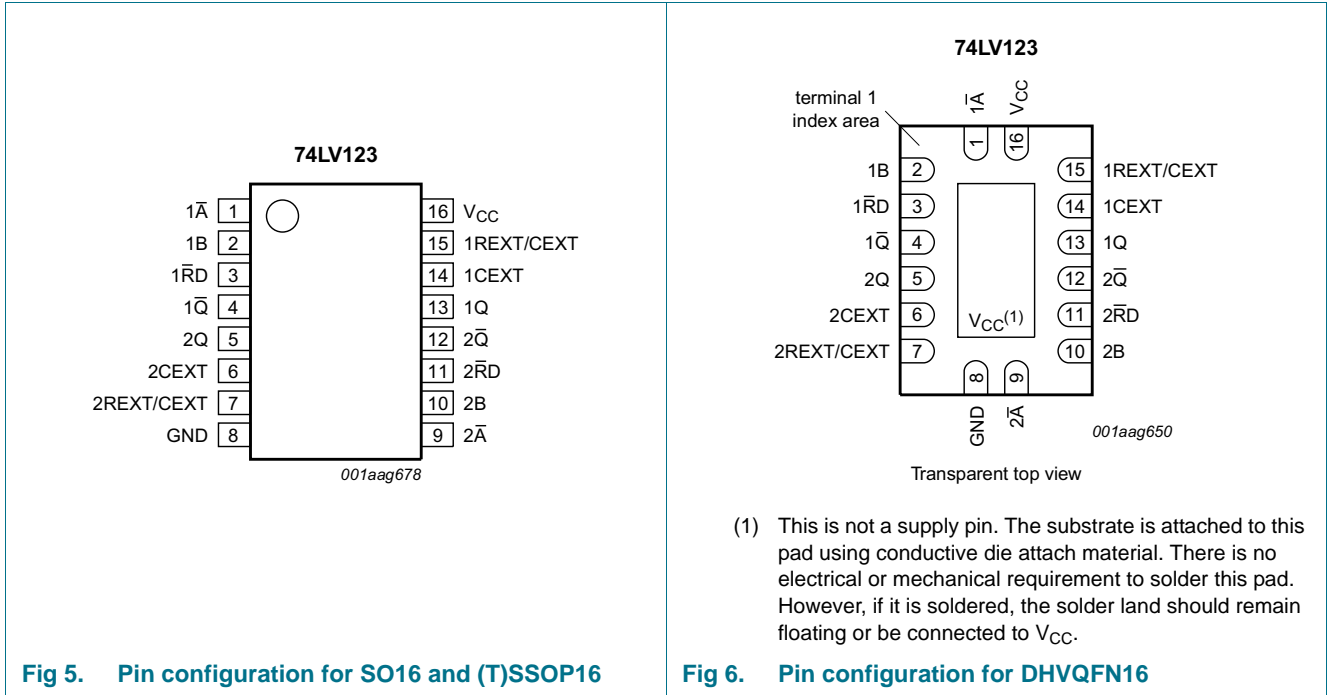


Fig 4. Logic diagram

5. Pinning information

5.1 Pinning









5.2 Pin description

Table 2. Pin description

| Symbol          | Pin | Description  |
|-----------------|-----|--|
| 1 $\bar{A}$     | 1   | negative-edge triggered input 1                      |
| 1B              | 2   | positive-edge triggered input 1                      |
| 1 $\bar{RD}$    | 3   | direct reset LOW and positive-edge triggered input 1 |
| 1 $\bar{Q}$     | 4   | active LOW output 1                                  |
| 2Q              | 5   | active HIGH output 2                                 |
| 2CEXT           | 6   | external capacitor connection 2                      |
| 2REXT/CEXT      | 7   | external resistor and capacitor connection 2         |
| GND             | 8   | ground (0 V)   |
| 2 $\bar{A}$     | 9   | negative-edge triggered input 2                      |
| 2B              | 10  | positive-edge triggered input 2                      |
| 2 $\bar{RD}$    | 11  | direct reset LOW and positive-edge triggered input 2 |
| 2 $\bar{Q}$     | 12  | active LOW output 2                                  |
| 1Q              | 13  | active HIGH output 1                                 |
| 1CEXT           | 14  | external capacitor connection 1                      |
| 1REXT/CEXT      | 15  | external resistor and capacitor connection 1         |
| V <sub>CC</sub> | 16  | supply voltage                                       |


## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input |    |    | Output  |   |
|-------|----|----|---|---|
| nRD   | nA | nB | nQ  | nQ  |
| L     | X  | X  | L   | H   |
| X     | H  | X  | L <sup>[2]</sup>  | H <sup>[2]</sup>  |
| X     | X  | L  | L <sup>[2]</sup>  | H <sup>[2]</sup>  |
| H     | L  | ↑  |  |  |
| H     | ↓  | H  |  |  |
| ↑     | L  | H  |  |  |

- [1] H = HIGH voltage level;
- L = LOW voltage level;
- X = don't care;
- ↑ = LOW-to-HIGH transition;
- ↓ = HIGH-to-LOW transition;

 = one HIGH level output pulse

 = one LOW level output pulse

- [2] If the monostable multivibrator was triggered before this condition was established, the pulse will continue as programmed.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions  | Min  | Max      | Unit |
|-----------|-------------------------|---|------|----------|------|
| $V_{CC}$  | supply voltage          |   | -0.5 | +7       | V    |
| $I_{IK}$  | input clamping current  | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ [1]                            | -    | $\pm 20$ | mA   |
| $I_{OK}$  | output clamping current | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ [1]                            | -    | $\pm 50$ | mA   |
| $I_O$     | output current          | except for pins nREXT/CEXT;<br>$V_O = -0.5\text{ V}$ to $(V_{CC} + 0.5\text{ V})$ [1] | -    | $\pm 25$ | mA   |
| $I_{CC}$  | supply current          |   | -    | +50      | mA   |
| $I_{GND}$ | ground current          |   | -50  | -        | mA   |
| $T_{stg}$ | storage temperature     |   | -65  | +150     | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$   |      |          |      |
|           |                         | SO16 package [2]  | -    | 500      | mW   |
|           |                         | SSOP16 package [3]  | -    | 500      | mW   |
|           |                         | TSSOP16 package [3]   | -    | 500      | mW   |
|           |                         | DHVQFN16 package [4]  | -    | 500      | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO16 package:  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

[3] For SSOP16 and TSSOP16 packages:  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

[4] For DHVQFN16 package:  $P_{tot}$  derates linearly with 4.5 mW/K above 60 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                                    | Min | Typ | Max      | Unit |
|---------------------|-------------------------------------|---|-----|-----|----------|------|
| $V_{CC}$            | supply voltage                      | [1]   | 1.0 | 3.3 | 5.5      | V    |
| $V_I$               | input voltage                       |   | 0   | -   | $V_{CC}$ | V    |
| $V_O$               | output voltage                      |   | 0   | -   | $V_{CC}$ | V    |
| $T_{amb}$           | ambient temperature                 | in free air                                   | -40 | +25 | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.0\text{ V}$ to $2.0\text{ V}$ [2] | -   | -   | 500      | ns/V |
|                     |                                     | $V_{CC} = 2.0\text{ V}$ to $2.7\text{ V}$     | -   | -   | 200      | ns/V |
|                     |                                     | $V_{CC} = 2.7\text{ V}$ to $3.6\text{ V}$     | -   | -   | 100      | ns/V |
|                     |                                     | $V_{CC} = 3.6\text{ V}$ to $5.5\text{ V}$     | -   | -   | 50       | ns/V |

[1] The 74LV123 is guaranteed to function down to  $V_{CC} = 1.0\text{ V}$  (input levels GND or  $V_{CC}$ ); [Section 9 "Static characteristics"](#) are guaranteed from  $V_{CC} = 1.2\text{ V}$  to  $V_{CC} = 5.5\text{ V}$ .

[2] Except for Schmitt-trigger inputs  $\overline{nA}$  and  $nB$ .



## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                                    | Parameter                 | Conditions   | Min                   | Typ <sup>[1]</sup> | Max                   | Unit |
|---|---------------------------|--|-----------------------|--------------------|-----------------------|------|
| <b>T<sub>amb</sub> = -40 °C to +85 °C</b> |                           |  |                       |                    |                       |      |
| V <sub>IH</sub>                           | HIGH-level input voltage  | V <sub>CC</sub> = 1.2 V  | 0.9                   | -                  | -                     | V    |
|   |                           | V <sub>CC</sub> = 2.0 V  | 1.4                   | -                  | -                     | V    |
|   |                           | V <sub>CC</sub> = 2.7 V to 3.6 V   | 2.0                   | -                  | -                     | V    |
|   |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | 0.7 × V <sub>CC</sub> | -                  | -                     | V    |
| V <sub>IL</sub>                           | LOW-level input voltage   | V <sub>CC</sub> = 1.2 V  | -                     | -                  | 0.3                   | V    |
|   |                           | V <sub>CC</sub> = 2.0 V  | -                     | -                  | 0.6                   | V    |
|   |                           | V <sub>CC</sub> = 2.7 V to 3.6 V   | -                     | -                  | 0.8                   | V    |
|   |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | -                     | -                  | 0.3 × V <sub>CC</sub> | V    |
| V <sub>OH</sub>                           | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |                       |                    |                       |      |
|   |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.2 V                                      | -                     | 1.2                | -                     | V    |
|   |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.0 V                                      | 1.8                   | 2.0                | -                     | V    |
|   |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.7 V                                      | 2.5                   | 2.7                | -                     | V    |
|   |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 3.0 V                                      | 2.8                   | 3.0                | -                     | V    |
|   |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 4.5 V                                      | 4.3                   | 4.5                | -                     | V    |
|   |                           | I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 3.0 V  | 2.40                  | 2.82               | -                     | V    |
|   |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 4.5 V                                       | 3.60                  | 4.20               | -                     | V    |
| V <sub>OL</sub>                           | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |                       |                    |                       |      |
|   |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.2 V                                       | -                     | 0                  | -                     | V    |
|   |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.0 V                                       | -                     | 0                  | 0.2                   | V    |
|   |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.7 V                                       | -                     | 0                  | 0.2                   | V    |
|   |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 3.0 V                                       | -                     | 0                  | 0.2                   | V    |
|   |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 4.5 V                                       | -                     | 0                  | 0.2                   | V    |
|   |                           | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 3.0 V   | -                     | 0.25               | 0.40                  | V    |
|   |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 4.5 V  | -                     | 0.35               | 0.55                  | V    |
| I <sub>I</sub>                            | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V                       | -                     | -                  | 1.0                   | μA   |
| I <sub>CC</sub>                           | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V | -                     | -                  | 20.0                  | μA   |
| ΔI <sub>CC</sub>                          | additional supply current | V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; V <sub>CC</sub> = 2.7 V to 3.6 V             | -                     | -                  | 500                   | μA   |
| C <sub>I</sub>                            | input capacitance         |  | -                     | 3.5                | -                     | pF   |

**Table 6. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol   | Parameter                 | Conditions   | Min                   | Typ <sup>[1]</sup> | Max                   | Unit |
|--|---------------------------|--|-----------------------|--------------------|-----------------------|------|
| <b>T<sub>amb</sub> = -40 °C to +125 °C</b>       |                           |  |                       |                    |                       |      |
| V <sub>IH</sub>                                  | HIGH-level input voltage  | V <sub>CC</sub> = 1.2 V  | 0.9                   | -                  | -                     | V    |
|  |                           | V <sub>CC</sub> = 2.0 V  | 1.4                   | -                  | -                     | V    |
|  |                           | V <sub>CC</sub> = 2.7 V to 3.6 V   | 2.0                   | -                  | -                     | V    |
|  |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | 0.7 × V <sub>CC</sub> | -                  | -                     | V    |
| V <sub>IL</sub>                                  | LOW-level input voltage   | V <sub>CC</sub> = 1.2 V  | -                     | -                  | 0.3                   | V    |
|  |                           | V <sub>CC</sub> = 2.0 V  | -                     | -                  | 0.6                   | V    |
|  |                           | V <sub>CC</sub> = 2.7 V to 3.6 V   | -                     | -                  | 0.8                   | V    |
|  |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | -                     | -                  | 0.3 × V <sub>CC</sub> | V    |
| V <sub>OH</sub>                                  | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |                       |                    |                       |      |
|  |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.2 V                                      | -                     | -                  | -                     | V    |
|  |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.0 V                                      | 1.8                   | -                  | -                     | V    |
|  |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.7 V                                      | 2.5                   | -                  | -                     | V    |
|  |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 3.0 V                                      | 2.8                   | -                  | -                     | V    |
|  |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 4.5 V                                      | 4.3                   | -                  | -                     | V    |
|  |                           | I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 3.0 V  | 2.2                   | -                  | -                     | V    |
| I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 4.5 V | 3.5                       | -  | -                     | V                  |                       |      |
| V <sub>OL</sub>                                  | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |                       |                    |                       |      |
|  |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.2 V                                       | -                     | -                  | -                     | V    |
|  |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.0 V                                       | -                     | -                  | 0.2                   | V    |
|  |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.7 V                                       | -                     | -                  | 0.2                   | V    |
|  |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 3.0 V                                       | -                     | -                  | 0.2                   | V    |
|  |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 4.5 V                                       | -                     | -                  | 0.2                   | V    |
|  |                           | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 3.0 V   | -                     | -                  | 0.5                   | V    |
| I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 4.5 V  | -                         | -  | 0.65                  | V                  |                       |      |
| I <sub>I</sub>                                   | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V                       | -                     | -                  | 1.0                   | μA   |
| I <sub>CC</sub>                                  | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V | -                     | -                  | 160                   | μA   |
| ΔI <sub>CC</sub>                                 | additional supply current | V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; V <sub>CC</sub> = 2.7 V to 3.6 V             | -                     | -                  | 850                   | μA   |

[1] All typical values are measured at T<sub>amb</sub> = 25 °C.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

$GND = 0 V$ ;  $t_r = t_f \leq 2.5 ns$ ; for test circuit see [Figure 8](#).

| Symbol  | Parameter         | Conditions  | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |     | Unit |
|---|-------------------|---|------------------|--------------------|-----|-------------------|-----|------|
|   |                   |   | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |
| <b>Propagation delay; see <a href="#">Figure 7</a></b>  |                   |   |                  |                    |     |                   |     |      |
| $t_{pd}$  | propagation delay | $\overline{nRD}$ , $\overline{nA}$ and $nB$ to $n\overline{Q}$ <sup>[2]</sup> |                  |                    |     |                   |     |      |
|   |                   | $V_{CC} = 1.2 V$  | -                | 120                | -   | -                 | -   | ns   |
|   |                   | $V_{CC} = 2.0 V$  | -                | 40                 | 76  | -                 | 92  | ns   |
|   |                   | $V_{CC} = 2.7 V$  | -                | 30                 | 56  | -                 | 68  | ns   |
|   |                   | $V_{CC} = 3.0 V$ to $3.6 V$   | -                | 25                 | 48  | -                 | 57  | ns   |
|   |                   | $V_{CC} = 4.5 V$ to $5.5 V$   | -                | 18                 | 40  | -                 | 46  | ns   |
|   |                   | $\overline{nRD}$ to $nQ$ (reset) <sup>[2]</sup>                               |                  |                    |     |                   |     |      |
|   |                   | $V_{CC} = 1.2 V$  | -                | 100                | -   | -                 | -   | ns   |
|   |                   | $V_{CC} = 2.0 V$  | -                | 30                 | 57  | -                 | 68  | ns   |
|   |                   | $V_{CC} = 2.7 V$  | -                | 23                 | 43  | -                 | 51  | ns   |
|   |                   | $V_{CC} = 3.0 V$ to $3.6 V$   | -                | 20                 | 38  | -                 | 45  | ns   |
|   |                   | $V_{CC} = 4.5 V$ to $5.5 V$   | -                | 14                 | 31  | -                 | 36  | ns   |
| <b>Inputs <math>nA</math>, <math>nB</math> and <math>nRD</math>; see <a href="#">Figure 7</a></b> |                   |   |                  |                    |     |                   |     |      |
| $t_w$   | pulse width       | $\overline{nA} = LOW$   |                  |                    |     |                   |     |      |
|   |                   | $V_{CC} = 2.0 V$  | 30               | 5                  | -   | 40                | -   | ns   |
|   |                   | $V_{CC} = 2.7 V$  | 25               | 3.5                | -   | 30                | -   | ns   |
|   |                   | $V_{CC} = 3.0 V$ to $3.6 V$   | 20               | 3.0                | -   | 25                | -   | ns   |
|   |                   | $V_{CC} = 4.5 V$ to $5.5 V$   | 15               | 2.5                | -   | 20                | -   | ns   |
|   |                   | $nB = HIGH$   |                  |                    |     |                   |     |      |
|   |                   | $V_{CC} = 2.0 V$  | 30               | 13                 | -   | 40                | -   | ns   |
|   |                   | $V_{CC} = 2.7 V$  | 25               | 8                  | -   | 30                | -   | ns   |
|   |                   | $V_{CC} = 3.0 V$ to $3.6 V$   | 20               | 7                  | -   | 25                | -   | ns   |
|   |                   | $V_{CC} = 4.5 V$ to $5.5 V$   | 15               | 5                  | -   | 20                | -   | ns   |
|   |                   | $\overline{nRD} = LOW$ ; see <a href="#">Figure 13</a>                        |                  |                    |     |                   |     |      |
|   |                   | $V_{CC} = 2.0 V$  | 35               | 6                  | -   | 45                | -   | ns   |
|   |                   | $V_{CC} = 2.7 V$  | 30               | 5                  | -   | 40                | -   | ns   |
|   |                   | $V_{CC} = 3.0 V$ to $3.6 V$   | 25               | 4                  | -   | 30                | -   | ns   |
|   |                   | $V_{CC} = 4.5 V$ to $5.5 V$   | 20               | 3                  | -   | 25                | -   | ns   |
| $t_{trig}$  | retrigger time    | $nB$ to $\overline{nA}$ ; see <a href="#">Figure 12</a>                       |                  |                    |     |                   |     |      |
|   |                   | $V_{CC} = 2.0 V$  | -                | 70                 | -   | -                 | -   | ns   |
|   |                   | $V_{CC} = 2.7 V$  | -                | 55                 | -   | -                 | -   | ns   |
|   |                   | $V_{CC} = 3.0 V$ to $3.6 V$   | -                | 45                 | -   | -                 | -   | ns   |
|   |                   | $V_{CC} = 4.5 V$ to $5.5 V$   | -                | 40                 | -   | -                 | -   | ns   |

**Table 7. Dynamic characteristics ...continued**  
*GND = 0 V;  $t_r = t_f \leq 2.5$  ns; for test circuit see [Figure 8](#).*

| Symbol   | Parameter                     | Conditions  | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |     | Unit |
|--|-------------------------------|---|------------------|--------------------|------|-------------------|-----|------|
|  |                               |   | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max |      |
| <b>Outputs; nQ = LOW and nQ = HIGH, see <a href="#">Figure 7</a></b> |                               |   |                  |                    |      |                   |     |      |
| t <sub>w</sub>   | pulse width                   | C <sub>EXT</sub> = 100 nF; R <sub>EXT</sub> = 10 kΩ                             |                  |                    |      |                   |     |      |
|  |                               | V <sub>CC</sub> = 2.0 V   | -                | 470                | -    | -                 | -   | ns   |
|  |                               | V <sub>CC</sub> = 2.7 V   | -                | 460                | -    | -                 | -   | ns   |
|  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V  | -                | 450                | -    | -                 | -   | ns   |
|  |                               | V <sub>CC</sub> = 4.5 V to 5.5 V  | -                | 430                | -    | -                 | -   | ns   |
|  |                               | C <sub>EXT</sub> = 0 pF; R <sub>EXT</sub> = 5 kΩ                                |                  |                    |      |                   |     |      |
|  |                               | V <sub>CC</sub> = 2.0 V   | -                | 100                | -    | -                 | -   | ns   |
|  |                               | V <sub>CC</sub> = 2.7 V   | -                | 90                 | -    | -                 | -   | ns   |
|  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V  | -                | 80                 | -    | -                 | -   | ns   |
| V <sub>CC</sub> = 4.5 V to 5.5 V                                     | -                             | 70  | -                | -                  | -    | ns                |     |      |
| <b>External components</b>   |                               |   |                  |                    |      |                   |     |      |
| R <sub>EXT</sub>   | external resistance           | see <a href="#">Figure 11</a> <sup>[3]</sup>                                    |                  |                    |      |                   |     |      |
|  |                               | V <sub>CC</sub> = 1.2 V   | 10               | -                  | 1000 | -                 | -   | kΩ   |
|  |                               | V <sub>CC</sub> = 2.0 V   | 5                | -                  | 1000 | -                 | -   | kΩ   |
|  |                               | V <sub>CC</sub> = 2.7 V   | 3                | -                  | 1000 | -                 | -   | kΩ   |
|  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V  | 2                | -                  | 1000 | -                 | -   | kΩ   |
|  |                               | V <sub>CC</sub> = 4.5 V to 5.5 V  | 2                | -                  | 1000 | -                 | -   | kΩ   |
| C <sub>EXT</sub>   | external capacitance          | see <a href="#">Figure 11</a> <sup>[3]</sup><br><sup>[4]</sup>                  |                  |                    |      |                   |     |      |
|  |                               | V <sub>CC</sub> = 1.2 V   | -                | -                  | -    | -                 | -   | pF   |
|  |                               | V <sub>CC</sub> = 2.0 V   | -                | -                  | -    | -                 | -   | pF   |
|  |                               | V <sub>CC</sub> = 2.7 V   | -                | -                  | -    | -                 | -   | pF   |
|  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V  | -                | -                  | -    | -                 | -   | pF   |
|  |                               | V <sub>CC</sub> = 4.5 V to 5.5 V  | -                | -                  | -    | -                 | -   | pF   |
| <b>Dynamic power dissipation</b>                                     |                               |   |                  |                    |      |                   |     |      |
| C <sub>PD</sub>  | power dissipation capacitance | V <sub>CC</sub> = 3.3 V; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[5]</sup> | -                | 60                 | -    | -                 | -   | pF   |

[1] All typical values are measured at T<sub>amb</sub> = 25 °C and nominal supply values (V<sub>CC</sub> = 3.3 V and 5.0 V).

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>; C<sub>EXT</sub> = 0 pF; R<sub>EXT</sub> = 5 kΩ.

[3] For other R<sub>EXT</sub> and C<sub>EXT</sub> combinations see [Figure 11](#) and [Section 12.1.1 "Basic timing"](#).

[4] C<sub>EXT</sub> has no limits.

[5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

11. Waveforms

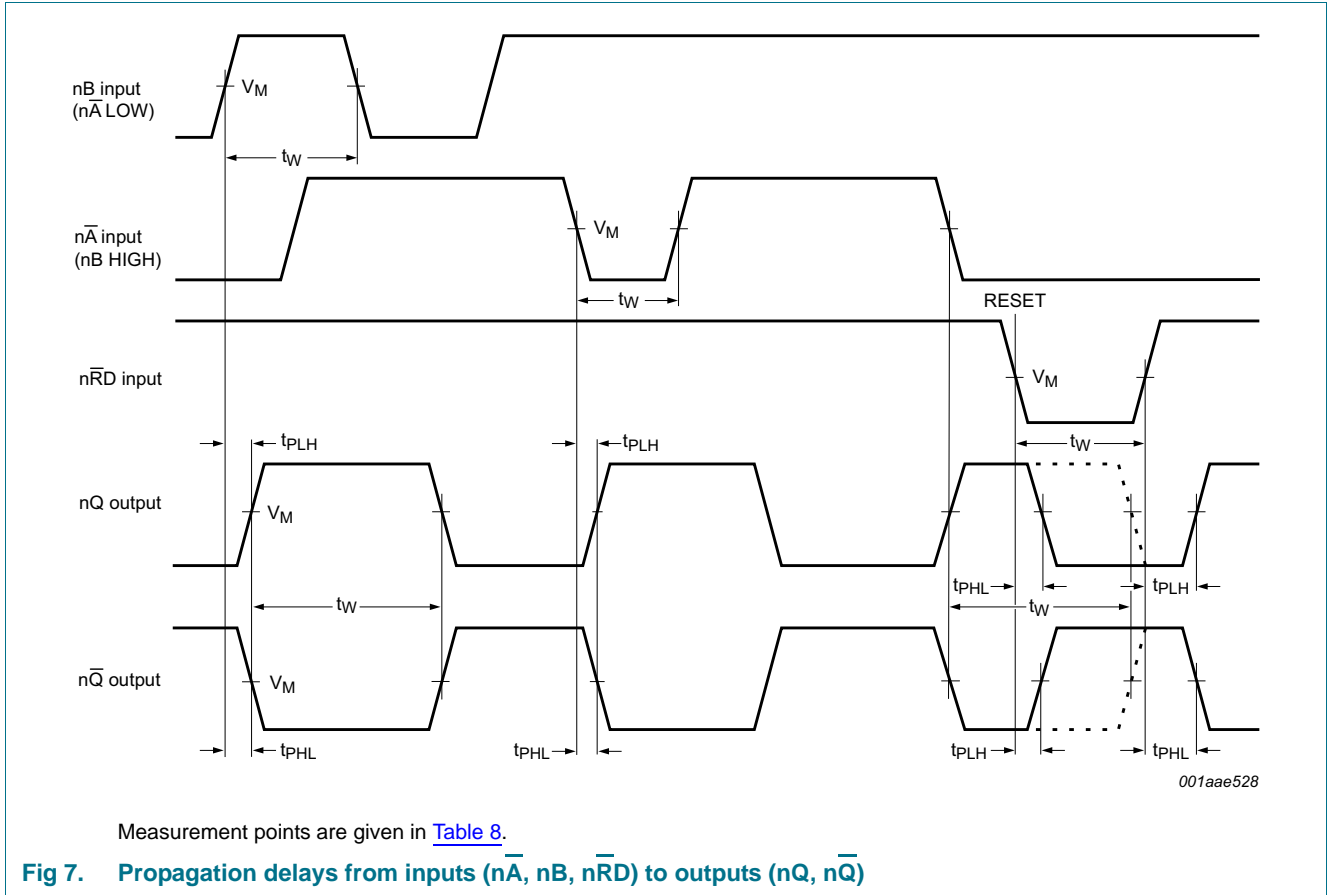


Table 8. Measurement points

| $V_{CC}$     | $V_M$               |
|--------------|---------------------|
| $\geq 2.7 V$ | 1.5 V               |
| $< 2.7 V$    | $0.5 \times V_{CC}$ |

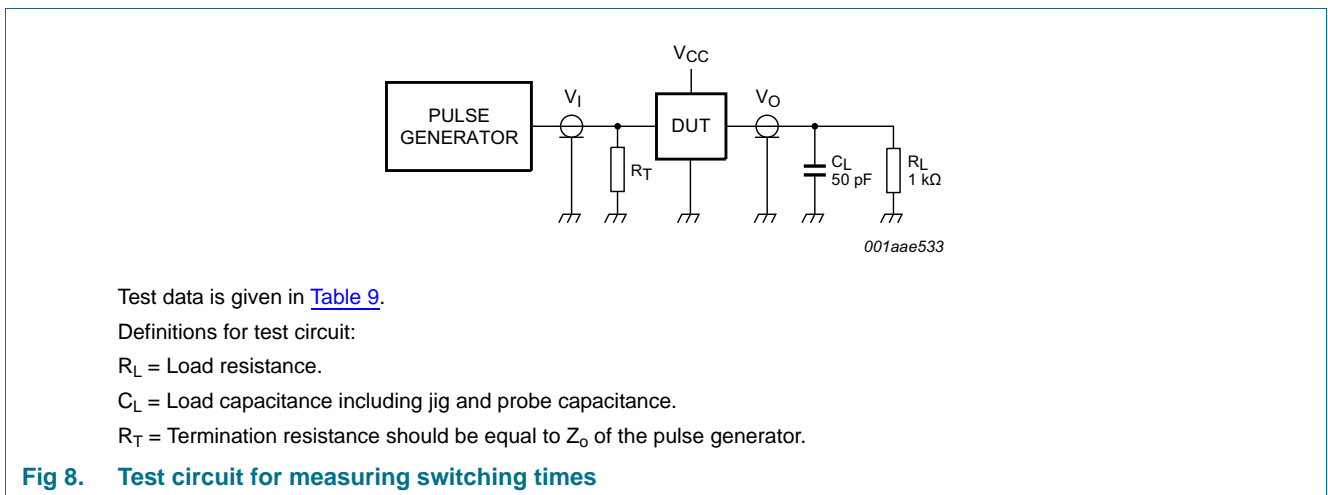


Table 9. Test data

| Supply voltage  | Input           |                                 | Load           |                | Test                                |
|-----------------|-----------------|---------------------------------|----------------|----------------|-------------------------------------|
| V <sub>CC</sub> | V <sub>I</sub>  | t <sub>r</sub> , t <sub>f</sub> | C <sub>L</sub> | R <sub>L</sub> |                                     |
| < 2.7 V         | V <sub>CC</sub> | ≤ 2.5 ns                        | 50 pF          | 1 kΩ           | t <sub>PHL</sub> , t <sub>PLH</sub> |
| 2.7 V to 3.6 V  | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 1 kΩ           | t <sub>PHL</sub> , t <sub>PLH</sub> |
| ≥ 4.5 V         | V <sub>CC</sub> | ≤ 2.5 ns                        | 50 pF          | 1 kΩ           | t <sub>PHL</sub> , t <sub>PLH</sub> |

## 12. Application information

### 12.1 Timing components

#### 12.1.1 Basic timing

The basic output pulse width is essentially determined by the values of the external timing components R<sub>EXT</sub> and C<sub>EXT</sub>.

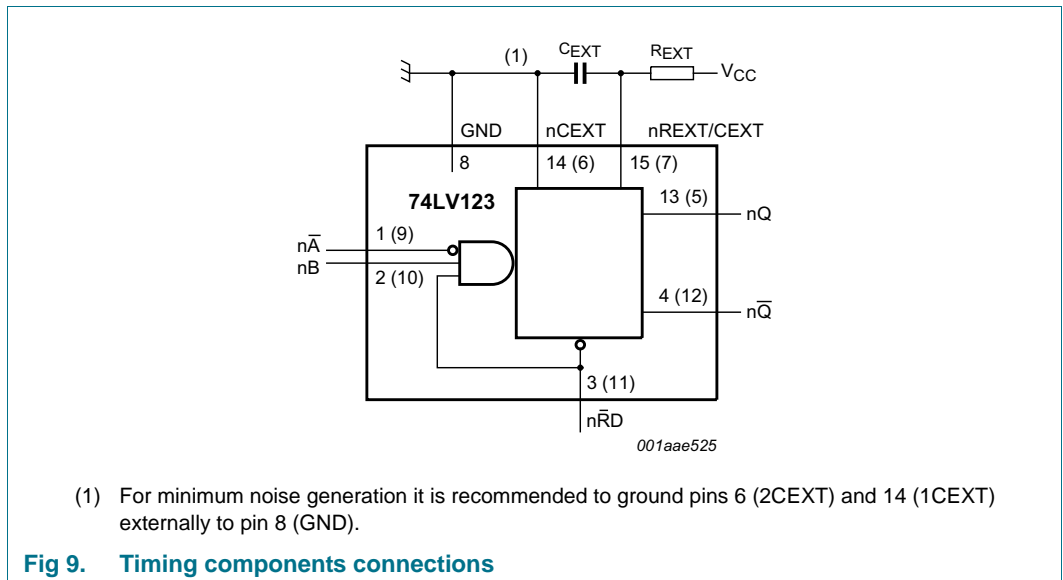


Fig 9. Timing components connections

If C<sub>EXT</sub> > 10 nF, the following formula is valid: t<sub>W</sub> = K × R<sub>EXT</sub> × C<sub>EXT</sub> (typ.) where:

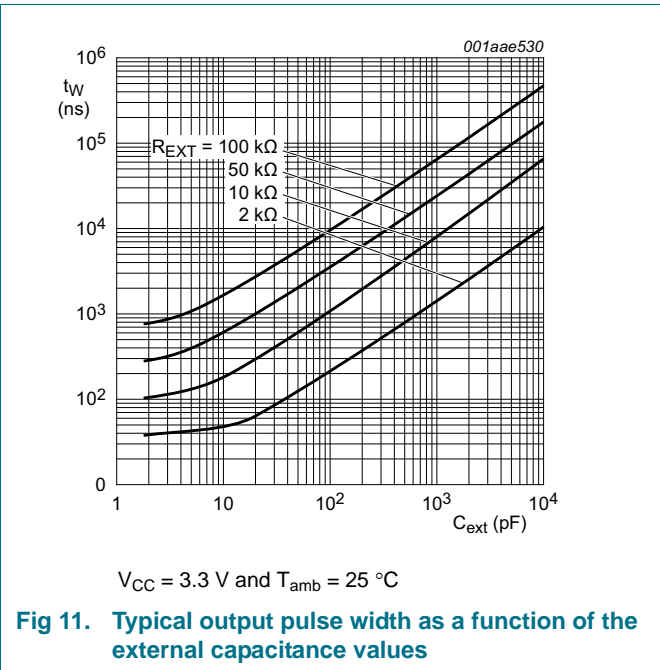
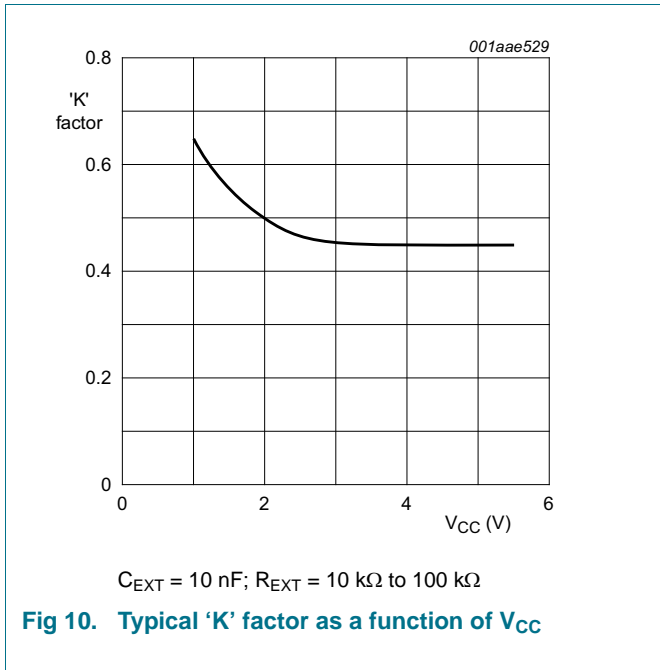
t<sub>W</sub> = output pulse width in ns

R<sub>EXT</sub> = external resistor in kΩ

C<sub>EXT</sub> = external capacitor in pF

K = constant: this is 0.45 for V<sub>CC</sub> = 5.0 V and 0.48 for V<sub>CC</sub> = 2.0 V (see [Figure 10](#))

The inherent test jig and pin capacitance at pin 15 and pin 7 (nREXT/CEXT) is approximately 7 pF.



**12.1.2 Retrigger timing**

The time to retrigger the monostable multivibrator depends on the values of  $R_{EXT}$  and  $C_{EXT}$ . The output pulse width will only be extended when the time between the active going edges of the trigger pulses meets the minimum retrigger time. If  $C_{EXT} > 10 \text{ pF}$ , the next formula for the set-up time of a retrigger pulse is valid:

at  $V_{CC} = 5.0 \text{ V}$ :  $t_{rtrig} = 30 + 0.19R_{EXT} \times C_{EXT}^{0.9} + 13 \times R_{EXT}^{1.05} \text{ (typ.)}$

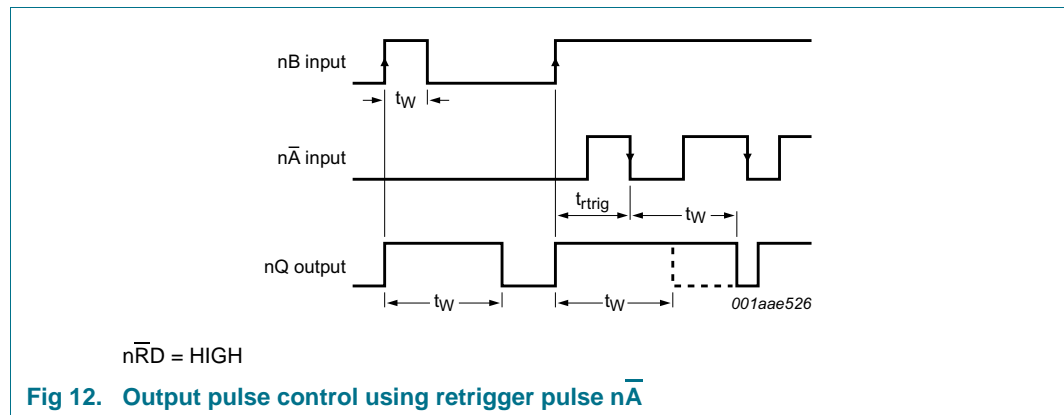
at  $V_{CC} = 3.0 \text{ V}$ :  $t_{rtrig} = 41 + 0.15R_{EXT} \times C_{EXT}^{0.9} \times 1 \times R_{EXT} \text{ (typ.)}$

where:

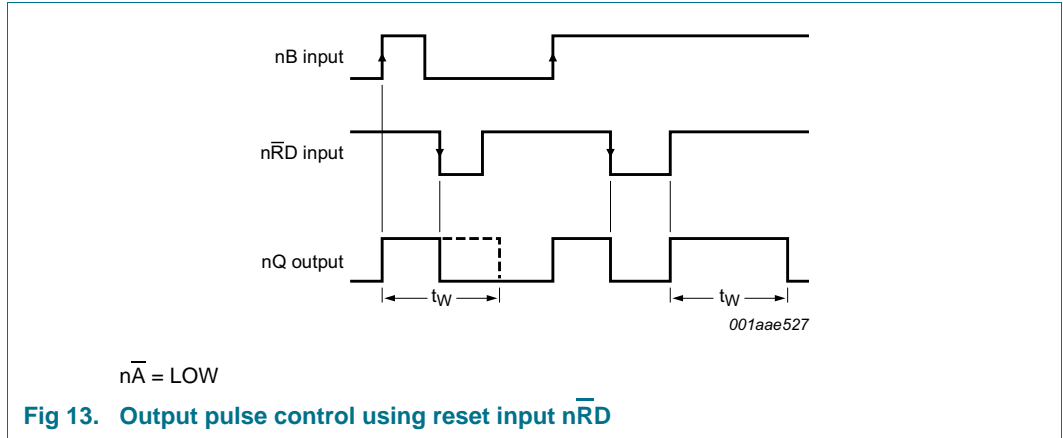
$t_{rtrig}$  = retrigger time in ns

$C_{EXT}$  = external capacitor in pF

$R_{EXT}$  = external resistor in k $\Omega$



12.1.3 Reset timing



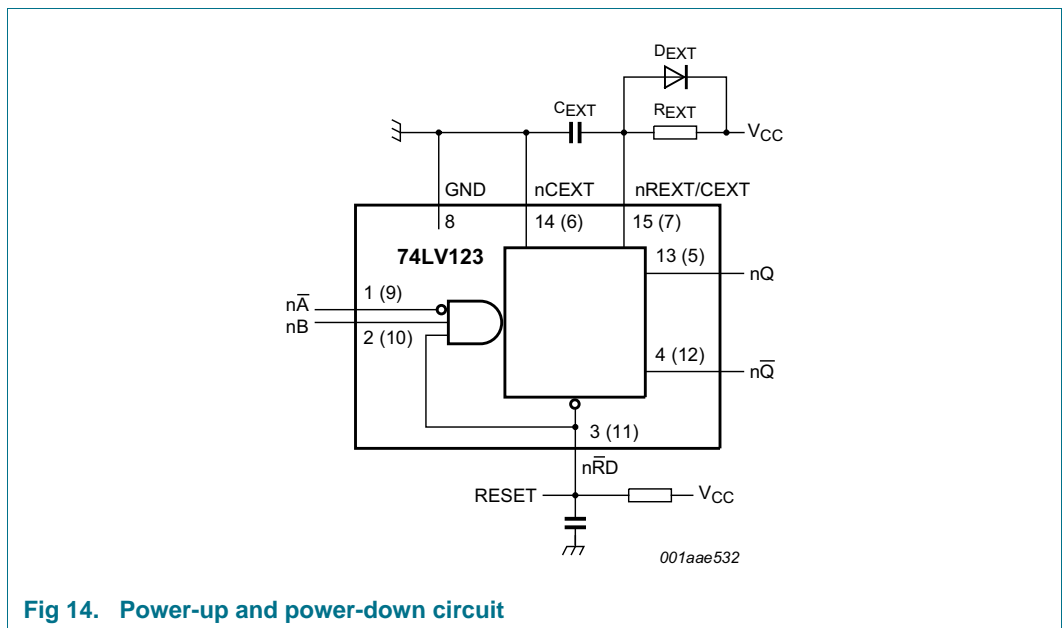
12.2 Power considerations

12.2.1 Power-up

When the monostable multivibrator is powered-up, it may produce an output pulse with a pulse width defined by the values of  $R_{EXT}$  and  $C_{EXT}$ . This output pulse can be eliminated using the RC circuit on pin  $\bar{nRD}$  shown in [Figure 14](#).

12.2.2 Power-down

A large capacitor ( $C_{EXT}$ ) may cause problems when powering-down the monostable due to the energy stored in this capacitor. When a system containing this device is powered-down or a rapid decrease of  $V_{CC}$  to zero occurs, the monostable may sustain damage, due to the capacitor discharging through the input protection diodes. To avoid this possibility, connect a damping diode  $D_{EXT}$  (preferably a germanium or Schottky type diode) able to withstand large current surges - see [Figure 14](#).





13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

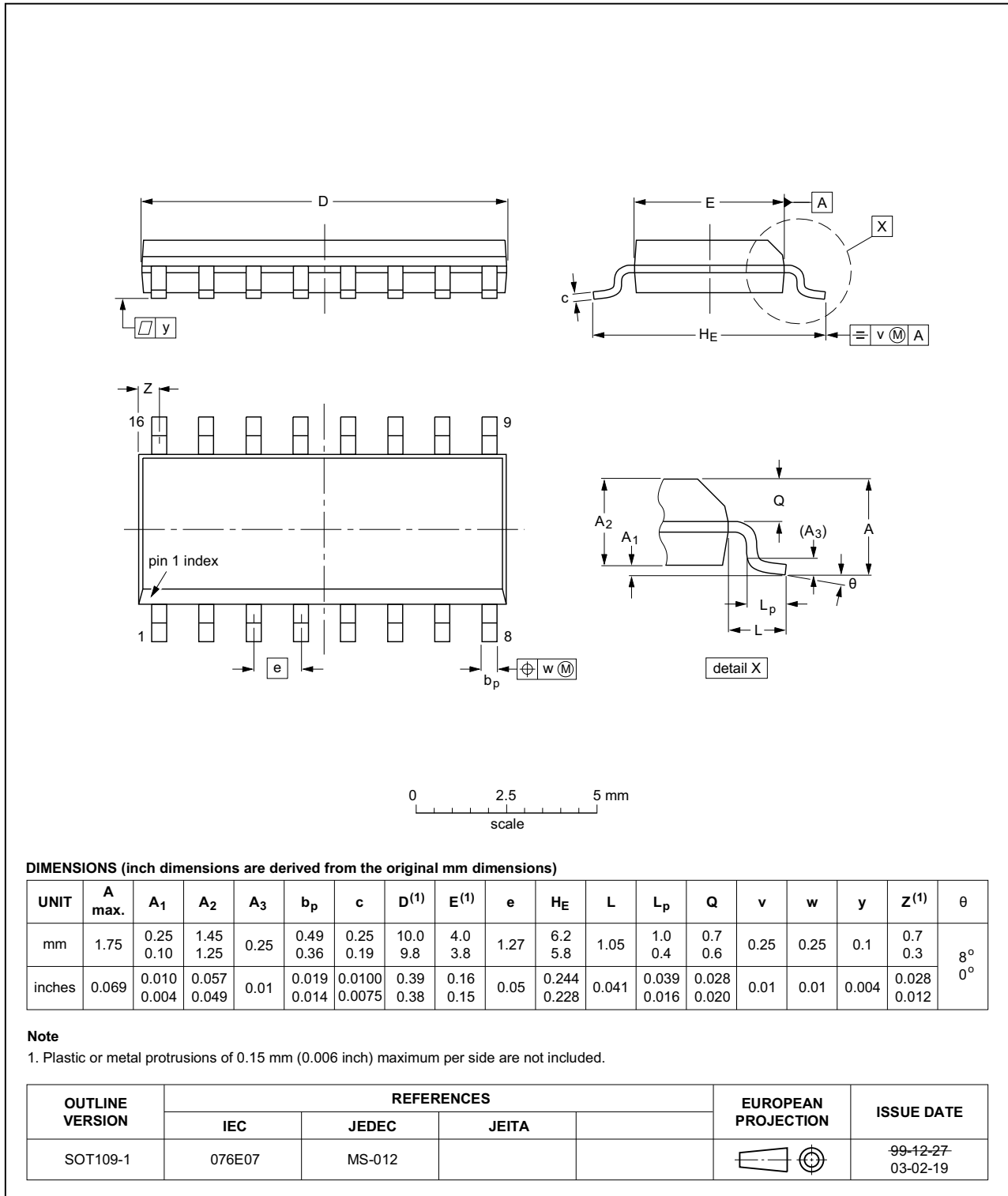


Fig 15. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

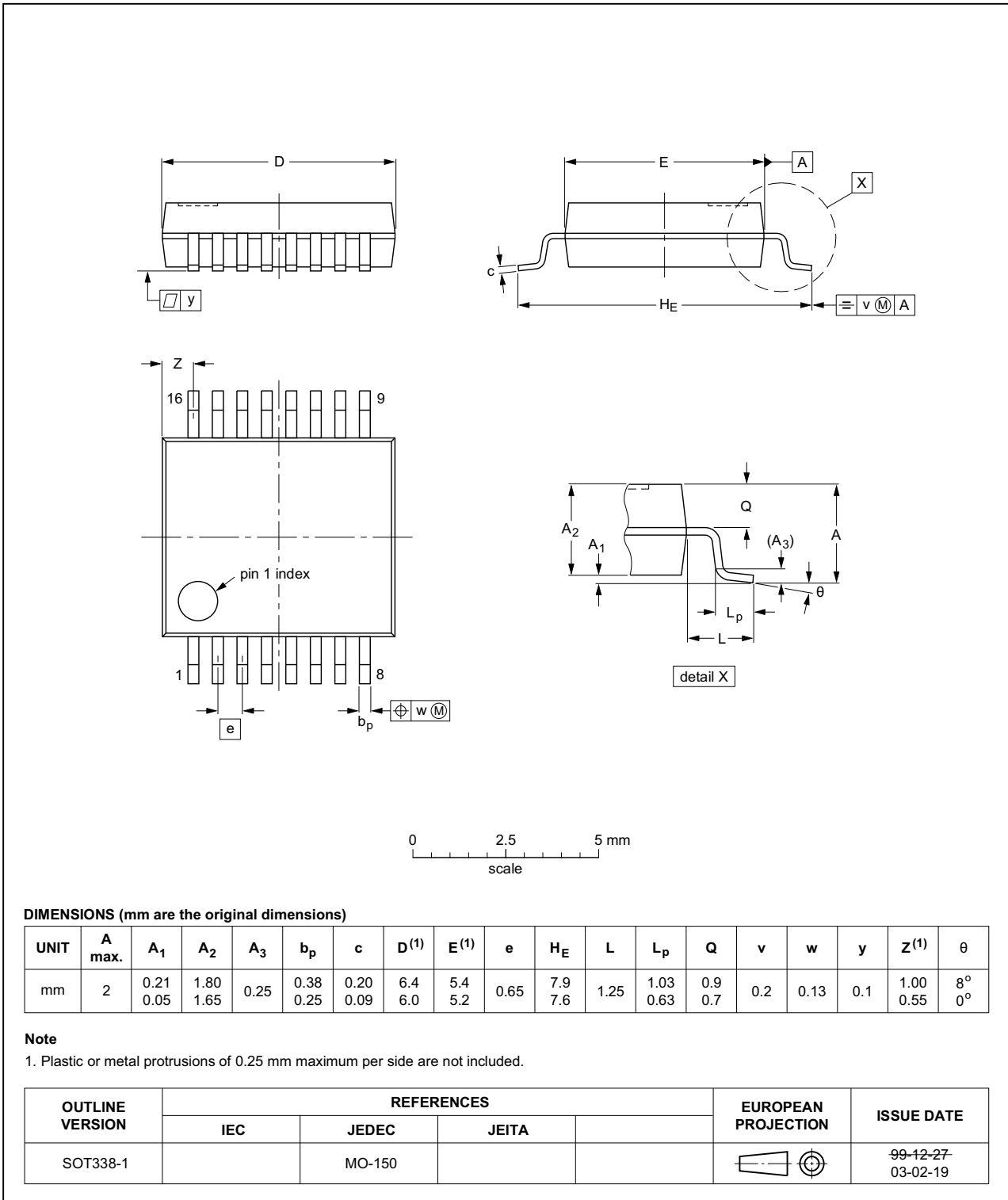


Fig 16. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

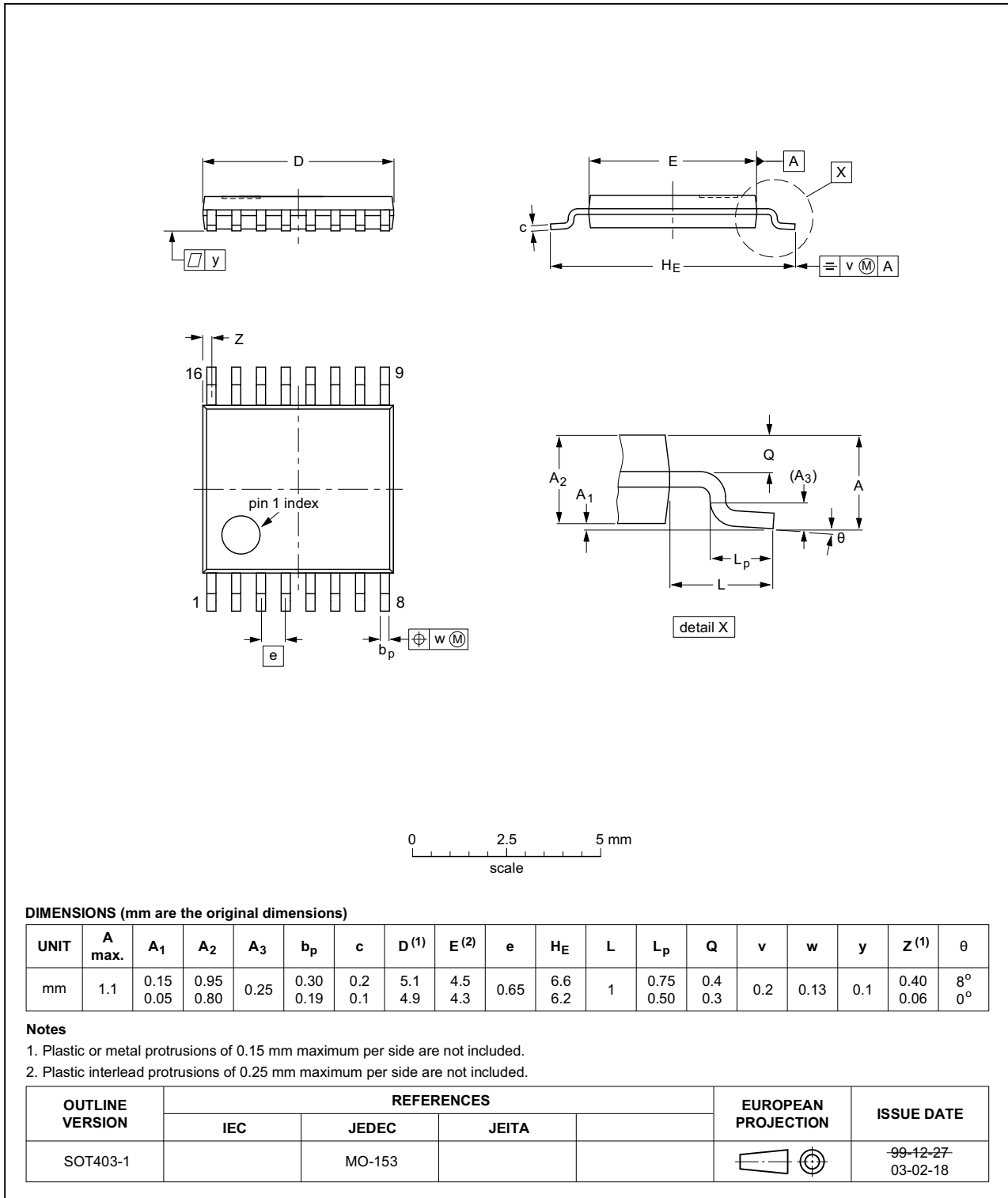


Fig 17. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm

SOT763-1

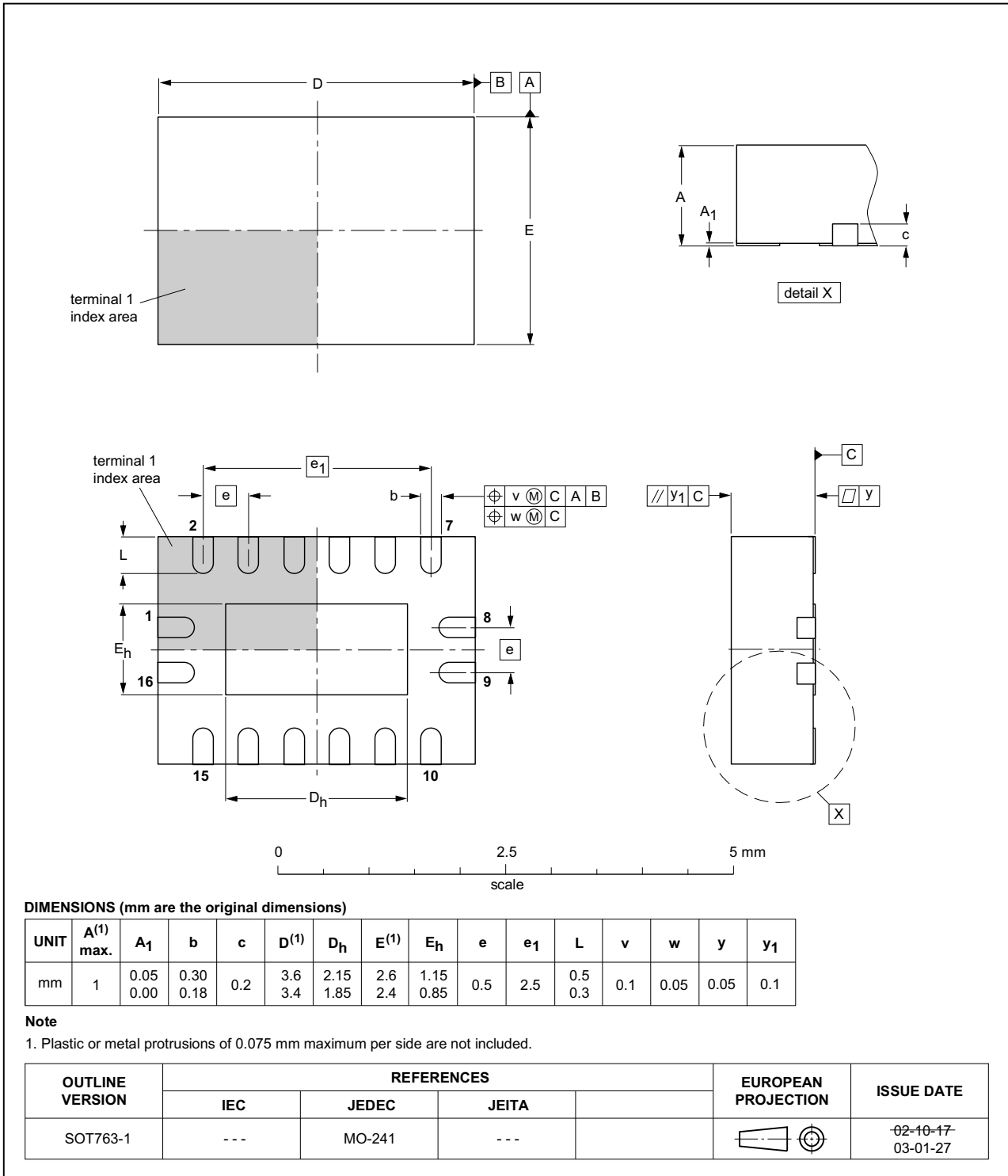


Fig 18. Package outline SOT763-1 (DHVQFN16)

## 14. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |

## 15. Revision history

Table 11. Revision history

| Document ID    | Release date   | Data sheet status     | Change notice | Supersedes  |
|----------------|--|-----------------------|---------------|-------------|
| 74LV123 v.8    | 20160304   | Product data sheet    | -             | 74LV123 v.7 |
| Modifications: | <ul style="list-style-type: none"> <li>Type numbers 74LV123N (SOT38-4) removed.</li> </ul> |                       |               |             |
| 74LV123 v.7    | 20111212   | Product data sheet    | -             | 74LV123 v.6 |
| Modifications: | <ul style="list-style-type: none"> <li>Legal pages updated.</li> </ul>                     |                       |               |             |
| 74LV123 v.6    | 20110826   | Product data sheet    | -             | 74LV123 v.5 |
| 74LV123 v.5    | 20071108   | Product data sheet    | -             | 74LV123 v.4 |
| 74LV123 v.4    | 20070919   | Product specification | -             | 74LV123 v.3 |
| 74LV123 v.3    | 20030313   | Product specification | -             | 74LV123 v.2 |
| 74LV123 v.2    | 19980420   | Product specification | -             | 74LV123 v.1 |
| 74LV123 v.1    | 19970204   | Product specification | -             | -           |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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